

April 1995

75A, 400V - 600V Hyperfast Diodes

Features

- Hyperfast with Soft Recovery.....<55ns
- Operating Temperature+175°C
- Reverse Voltage Up To600V
- Avalanche Energy Rated
- Planar Construction

Applications

- Switching Power Supplies
- Power Switching Circuits
- General Purpose

Description

RHRG7540, RHRG7550 and RHRG7560 are hyperfast diodes with soft recovery characteristics ($t_{RR} < 55\text{ns}$). They have half the recovery time of ultrafast diodes and are silicon nitride passivated ion-implanted epitaxial planar construction.

These devices are intended for use as freewheeling/clamping diodes and rectifiers in a variety of switching power supplies and other power switching applications. Their low stored charge and hyperfast soft recovery minimize ringing and electrical noise in many power switching circuits reducing power loss in the switching transistors.

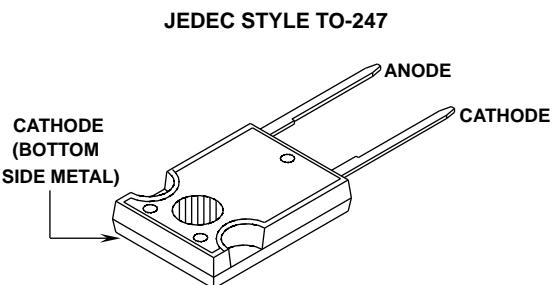
PACKAGING AVAILABILITY

PART NUMBER	PACKAGE	BRAND
RHRG7540	TO-247	RHRG7540
RHRG7550	TO-247	RHRG7550
RHRG7560	TO-247	RHRG7560

NOTE: When ordering, use the entire part number.

Formerly developmental type TA49067.

Package



Symbol



Absolute Maximum Ratings $T_C = +25^\circ\text{C}$, Unless Otherwise Specified

	RHRG7540	RHRG7550	RHRG7560	UNITS
Peak Repetitive Reverse Voltage.....	V_{RRM}	400	500	600
Working Peak Reverse Voltage	V_{RWM}	400	500	V
DC Blocking Voltage.....	V_R	400	500	V
Average Rectified Forward Current	$I_{F(AV)}$	75	75	A
($T_C = +80^\circ\text{C}$)				
Repetitive Peak Surge Current.....	I_{FSM}	150	150	A
(Square Wave, 20kHz)				
Nonrepetitive Peak Surge Current	I_{FSM}	750	750	A
(Halfwave, 1 phase, 60Hz)				
Maximum Power Dissipation	P_D	190	190	W
Avalanche Energy (See Figures 10 and 11).....	E_{AVL}	50	50	mj
Operating and Storage Temperature	T_{STG}, T_J	-65 to +175	-65 to +175	$^\circ\text{C}$

Specifications RHRG7540, RHRG7550, RHRG7560

Electrical Specifications $T_C = +25^\circ\text{C}$, Unless Otherwise Specified

SYMBOL	TEST CONDITION	RHRG7540			RHRG7550			RHRG7560			UNITS
		MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	
V_F	$I_F = 75\text{A}, T_C = +25^\circ\text{C}$	-	-	2.1	-	-	2.1	-	-	2.1	V
	$I_F = 75\text{A}, T_C = +150^\circ\text{C}$	-	-	1.7	-	-	1.7	-	-	1.7	V
I_R	$V_R = 400\text{V}, T_C = +25^\circ\text{C}$	-	-	500	-	-	-	-	-	-	μA
	$V_R = 500\text{V}, T_C = +25^\circ\text{C}$	-	-	-	-	-	500	-	-	-	μA
	$V_R = 600\text{V}, T_C = +25^\circ\text{C}$	-	-	-	-	-	-	-	-	500	μA
I_R	$V_R = 400\text{V}, T_C = +150^\circ\text{C}$	-	-	2.0	-	-	-	-	-	-	mA
	$V_R = 500\text{V}, T_C = +150^\circ\text{C}$	-	-	-	-	-	2.0	-	-	-	mA
	$V_R = 600\text{V}, T_C = +150^\circ\text{C}$	-	-	-	-	-	-	-	-	2.0	mA
t_{RR}	$I_F = 1\text{A}, dI_F/dt = 200\text{A}/\mu\text{s}$	-	-	55	-	-	55	-	-	55	ns
	$I_F = 75\text{A}, dI_F/dt = 200\text{A}/\mu\text{s}$	-	-	60	-	-	60	-	-	60	ns
t_A	$I_F = 75\text{A}, dI_F/dt = 200\text{A}/\mu\text{s}$	-	27	-	-	27	-	-	27	-	ns
t_B	$I_F = 75\text{A}, dI_F/dt = 200\text{A}/\mu\text{s}$	-	23	-	-	23	-	-	23	-	ns
Q_{RR}	$I_F = 75\text{A}, dI_F/dt = 200\text{A}/\mu\text{s}$	-	140	-	-	140	-	-	140	-	nC
C_J	$V_R = 10\text{V}, I_F = 0\text{A}$	-	200	-	-	200	-	-	200	-	pF
$R_{\theta JC}$		-	-	0.8	-	-	0.8	-	-	0.8	$^\circ\text{C}/\text{W}$

DEFINITIONS

V_F = Instantaneous forward voltage ($pw = 300\mu\text{s}$, $D = 2\%$).

I_R = Instantaneous reverse current .

t_{RR} = Reverse recovery time (See Figure 2), summation of $t_A + t_B$.

t_A = Time to reach peak reverse current (See Figure 2).

t_B = Time from peak I_{RM} to projected zero crossing of I_{RM} based on a straight line from peak I_{RM} through 25% of I_{RM} (See Figure 2).

Q_{RR} = Reverse recovery charge.

C_J = Junction Capacitance.

$R_{\theta JC}$ = Thermal resistance junction to case.

E_{AVL} = Controlled avalanche energy. (See Figures 10 and 11).

pw = pulse width.

D = duty cycle.

V_1 AMPLITUDE CONTROLS I_F

V_2 AMPLITUDE CONTROLS dI_F/dt

L_1 = SELF INDUCTANCE OF

$$R_4 + L_{\text{LOOP}}$$

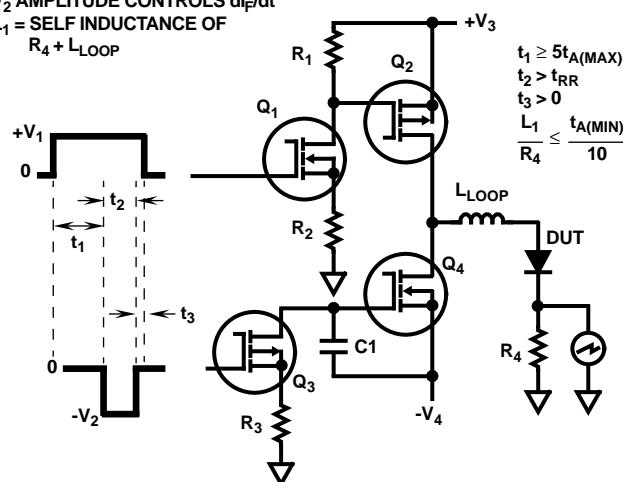


FIGURE 1. t_{RR} TEST CIRCUIT

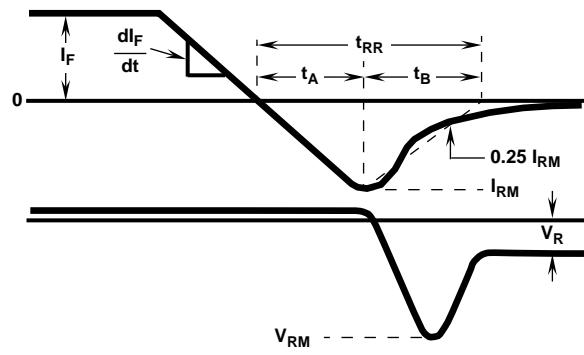


FIGURE 2. t_{RR} WAVEFORMS AND DEFINITIONS

Typical Performance Curves

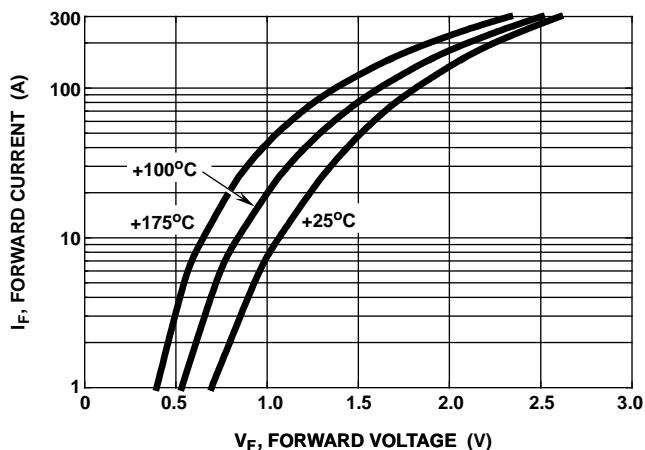


FIGURE 3. TYPICAL FORWARD CURRENT vs FORWARD VOLTAGE DROP

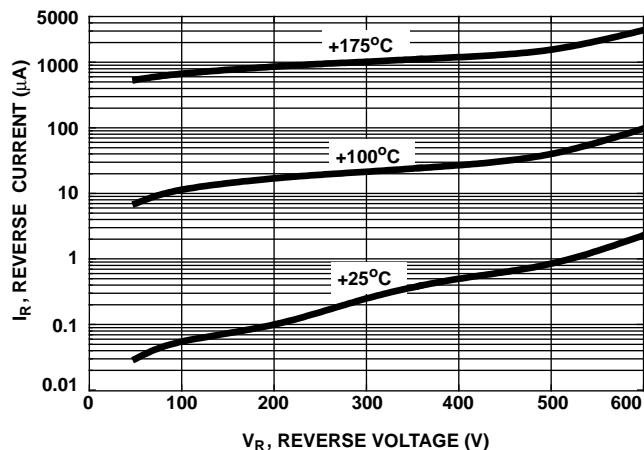


FIGURE 4. TYPICAL REVERSE CURRENT vs REVERSE VOLTAGE

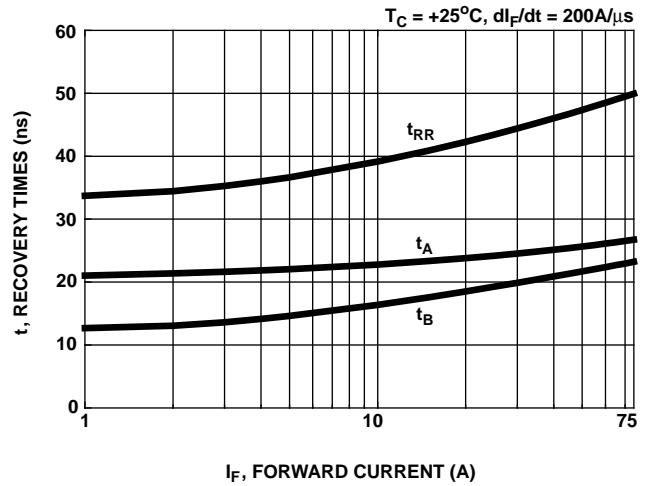


FIGURE 5. TYPICAL t_{RR}, t_A AND t_B CURVES vs FORWARD CURRENT AT +25°C

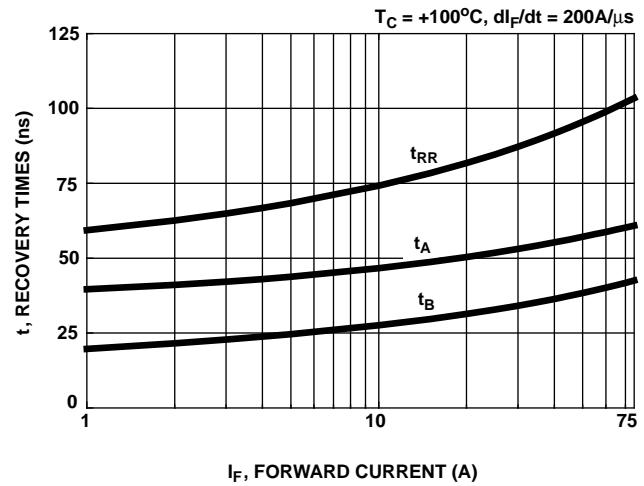


FIGURE 6. TYPICAL t_{RR}, t_A AND t_B CURVES vs FORWARD CURRENT AT +100°C

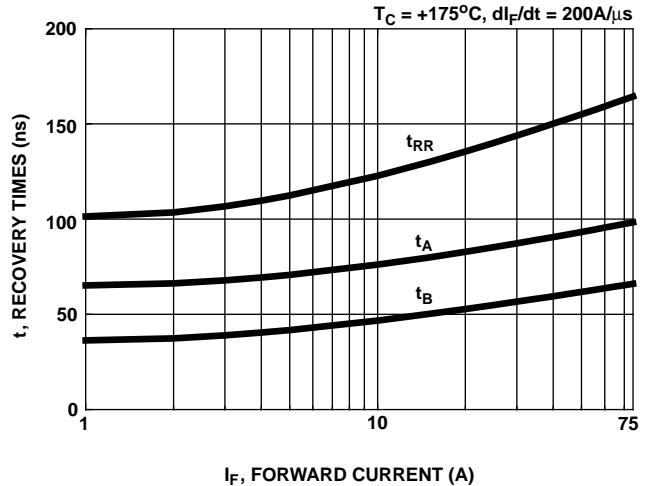


FIGURE 7. TYPICAL t_{RR}, t_A AND t_B CURVES vs FORWARD CURRENT AT +175°C

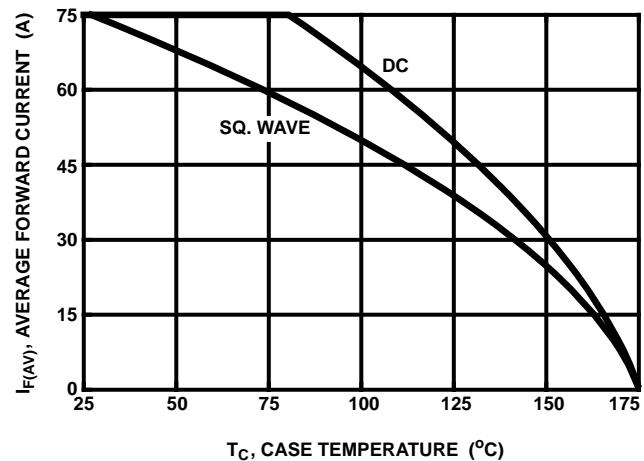


FIGURE 8. CURRENT DERATING CURVE FOR ALL TYPES

Typical Performance Curves (Continued)

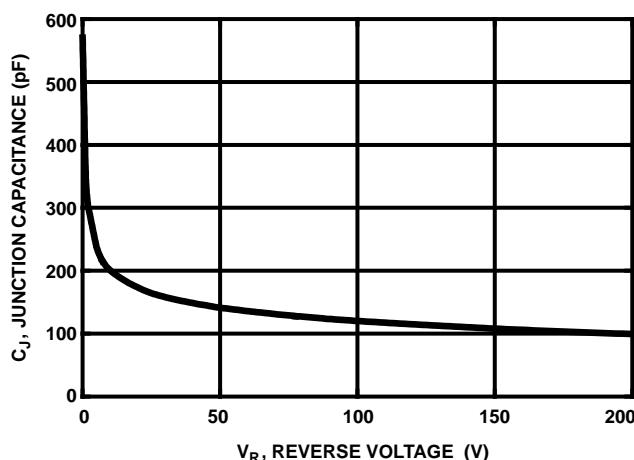


FIGURE 9. TYPICAL JUNCTION CAPACITANCE vs REVERSE VOLTAGE

Test Circuit and Waveforms

$I_{MAX} = 1A$

$L = 40mH$

$R < 0.1\Omega$

$$E_{AVL} = 1/2L^2 [V_{AVL}/(V_{AVL} - V_{DD})]$$

Q_1 AND Q_2 ARE 1000V MOSFETs

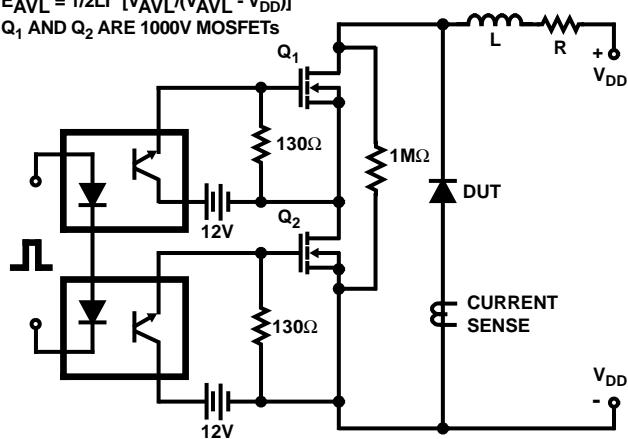


FIGURE 10. AVALANCHE ENERGY TEST CIRCUIT

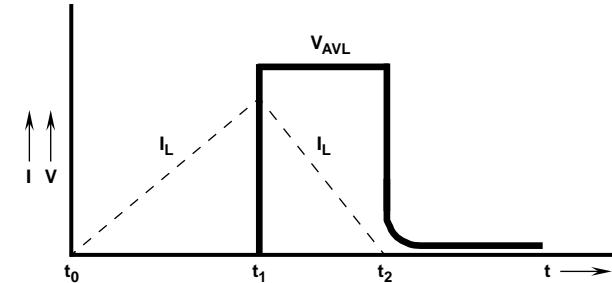


FIGURE 11. AVALANCHE CURRENT AND VOLTAGE WAVEFORMS